

SPECIFICATION

COMMERCIALY AVAILABLE

ITEM: DIELECTRIC CERAMIC FILTER
PART NUMBER: CF-05560203

Revision Made: 12/10/08 Added Land Pattern, changed Return Loss
3/12/10 changes to electrical

ISSUED	CHECKED	CHECKED	CHECKED	APPROVED
11/25/08 **				
12/10/08 pm				
3/12/10 kn				

FILTRONETICS Inc

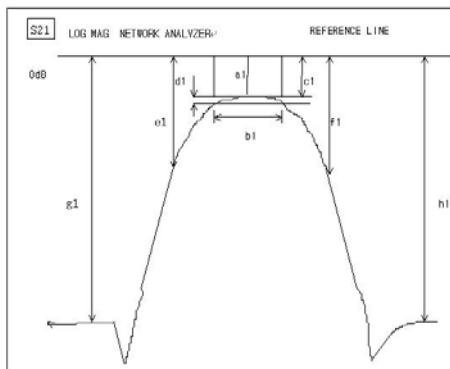
1. PART NUMBER:

PART NO	CF-05560203
PACKAGING	PLASTIC TRAY

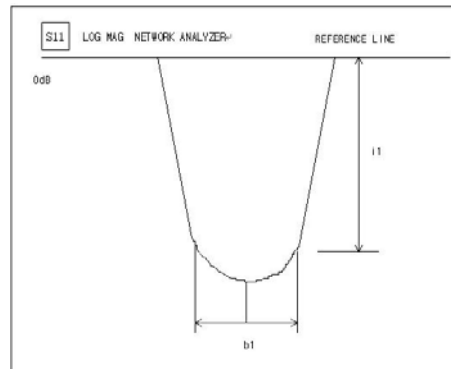
2. SPECIFICATION:

NO	ITEMS	Ref.	SPECIFICATION
1	Center Frequency (Fo)	a1	556 MHz
2	Pass Band Width (=PB)	-	Fo +/-10 MHz
3	3dB Band Width	-	29 MHz Min
4	Insertion Loss IN PB	-	2.15 dB Max
5	Ripple IN PB	-	0.5 dB Max
6	Attenuation	AT Fo+140MHz	50 dBc Min
		AT Fo-140MHz	50 dBc Min
7	Return Loss IN PB	-	13dB Min @-35 ~ +75°C
		-	15dB Min @ 25°C
8	Impedance	-	50Ω
9	Maximum Input Power	-	1 W (+30dBm)
10	Operating Temperature Range	-	-35 ~ +85°

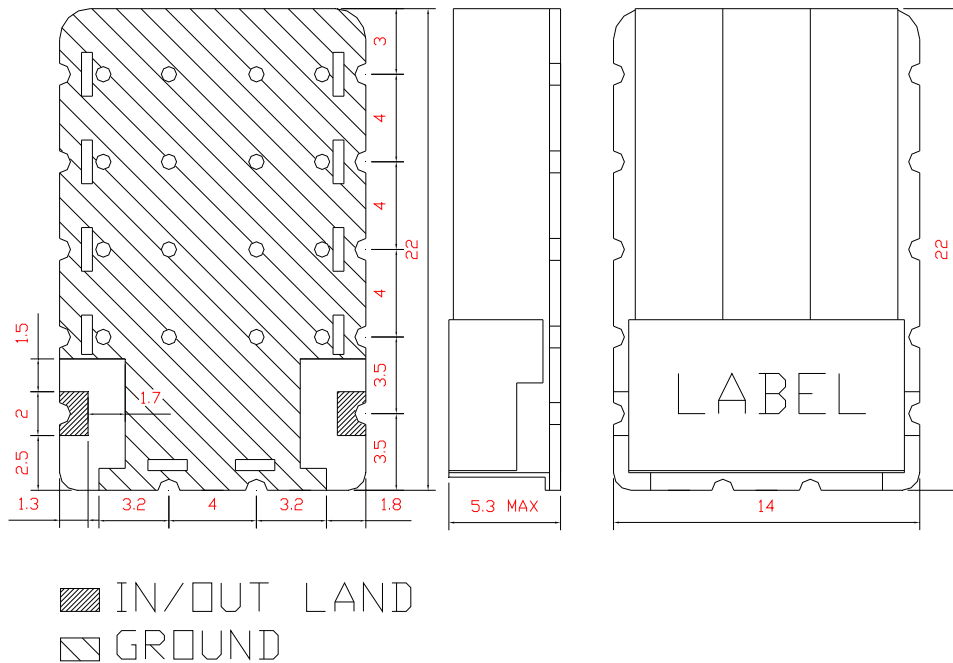
S21 LOG MAG NETWORK ANALYZER



S11 LOG MAG NETWORK ANALYZER



3. DIMENSIONS:



MATERIAL SPECIFICATION

1. PCB
 - 1) MATERIAL: FR4
 - 2) TERMINALS: Au PLATED
2. METAL CASE
 - 1) COVER MATERIAL: Brass (Sn OR Ni PLATED)
3. RESONATOR : Dielectric Resonator
 - 1) COATING MATERIAL: Ag
 - 2) Number of Poles : 3 Poles
4. ROHS Compliant.

The number of through holes may be changed without notice.

MARKING

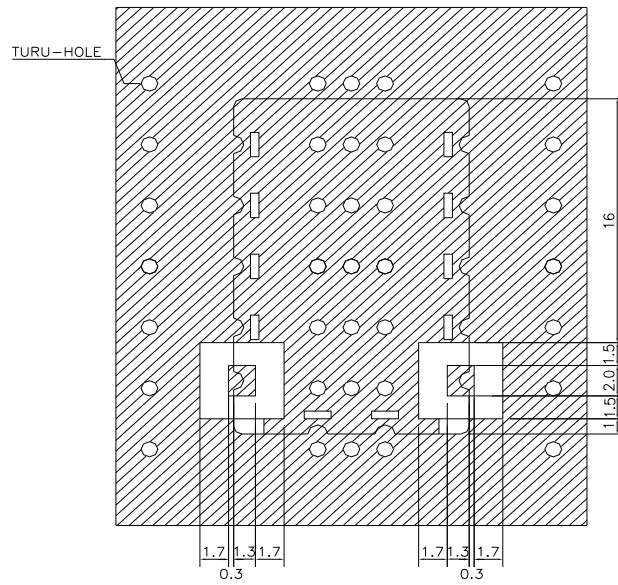
Part No: **CF-05560203**
 Filtronetics Inc
 Date Code

UNIT: MM
 TOLERANCE: +/-0.5MM
 IN/OUT LAND : +/-0.3MM

CAUTIONS:

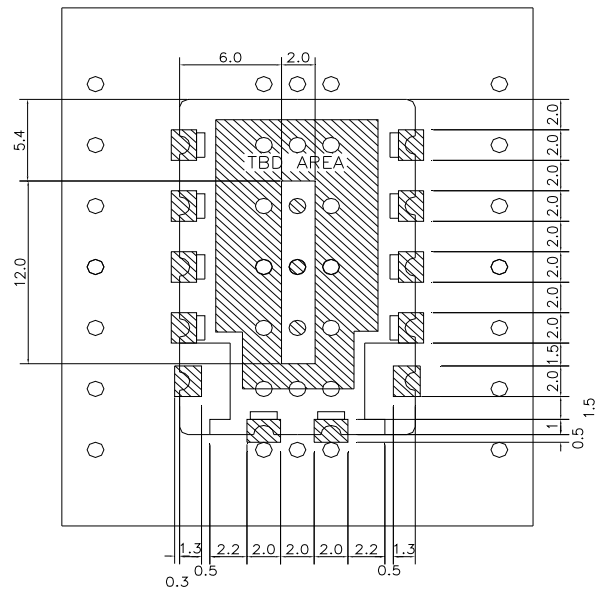
1. When handling products, be careful not to damage the outer-electrode.
2. When handling products be careful not to touch the outer-electrode with bare hands or solderability is reduced.
3. Do not apply excessive pressure or shock to product in handling or in transportation or damage to the ceramic filters may result.

Recommended Land Pattern



ELECTRODE

 CONDUCTIVE METAL
 FILTER OUTLINE

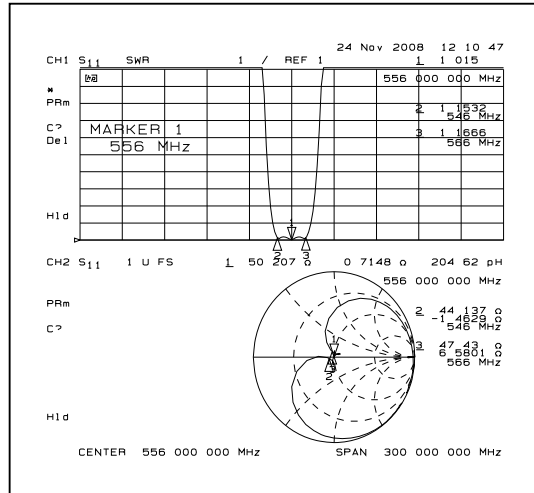
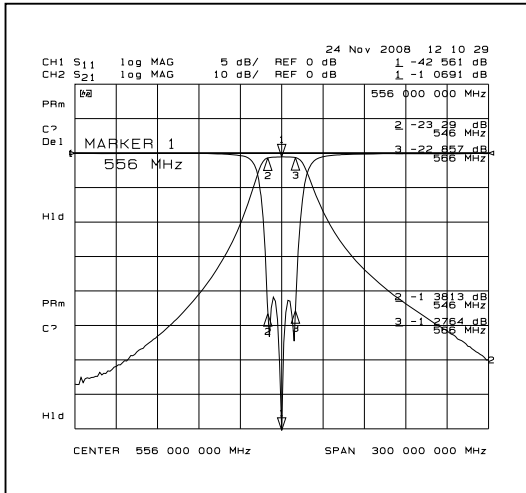


GROUND

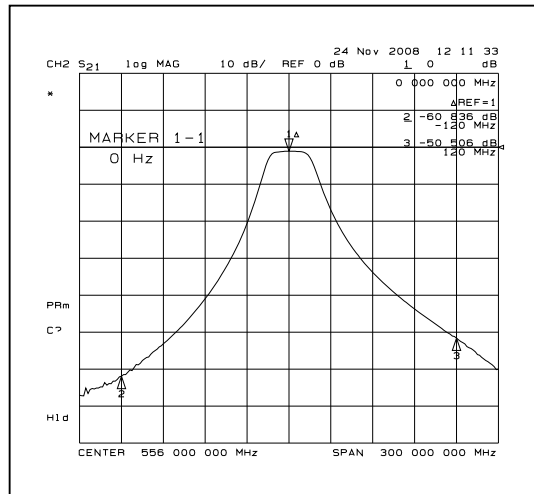
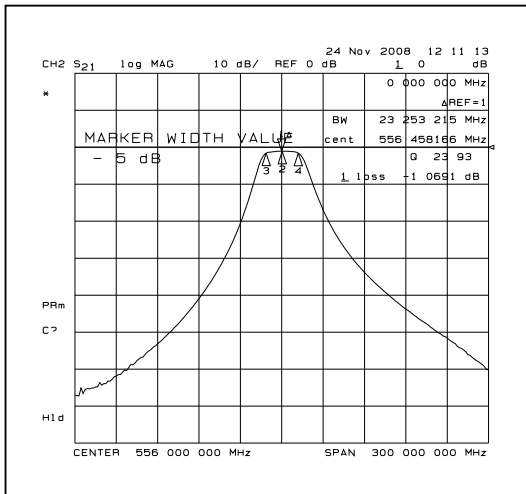
 GROUND SOLDERING
 FILTER OUTLINE

4. GRAPHS

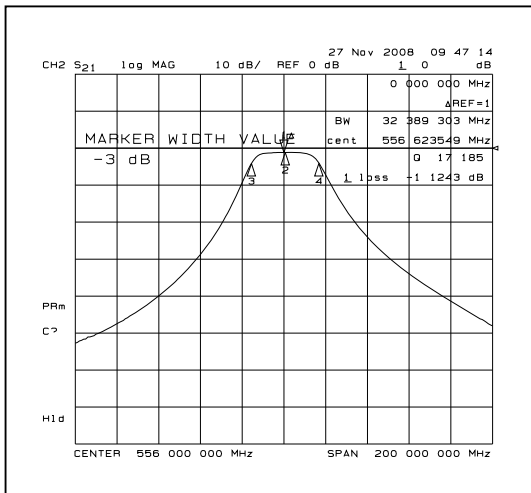
S21 & S11 (INSERTION LOSS, RETURN LOSS, V.S.W.R, SMITH CHART)



S21 (0.5 dB BAND WIDTH, ATTENUATION)



S21 (3.0 dB BAND WIDTH)



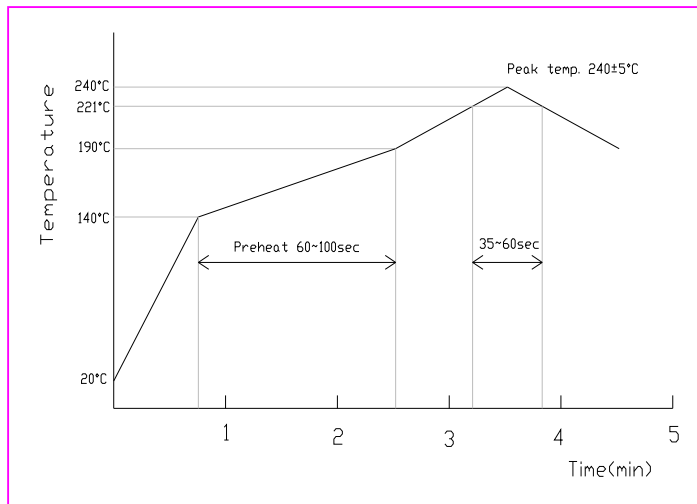
5. DEFINITIONS

TERMS	DESCRIPTION	SPECIFICATION
Center Frequency	The midpoint of through band pass filter pass band, normally expressed as the arithmetic mean of the -3db point. Also called f_0 .	3. SPECIFICATION
Pass Band Width	The width of the pass band of a filter referenced to the minimum insertion loss point in the pass band. The pass band of a filter is stated as -1.0dB bandwidth.	
Insertion Loss	The loss of the filter, in db, measured at center frequency relative to a through line (0 dB).	
Attenuation	Reduction of RF power through a filter measured in dB, at desired band and referenced to 0 dB. (Filter to be removed from circuit)	
Pass Band Ripple	Variations in loss in the pass band of the filter, superimposed upon the fundamental shape of the pass band.	
V.S.W.R in Pass Band	The ratio of the maximum value of a standing wave to its minimum value, related to the return loss in pass band.	

6. RELIABILITY TEST AND CONDITIONS

ITEM	TEST CONDITIONS	REQUIREMENTS
Resistance to solder heat	Preheat temperature : 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 260 +/- 10°C Dipping time: 10 +/- 0.5 sec	No damage such as cracks should be caused in chip element.
Solderability	Preheat temperature: 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 235 +/- 5°C Dipping time: 5 +/- 1 sec	More than 80% of the terminal electrode shall be covered with new solder
Heat resistance (High-temperature Load)	Temperature: 85 +/- 2°C Applied voltage: Rated voltage Applied current: Rated current Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Thermal shock (Temperature cycle)	Conditions for 1 cycle Step 1: + 85°C 15 min Step 2 : - 30°C 15 min Number of cycle: 10	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Humidity Resistance	Temperature: 40 +/- 2°C Humidity: 90 to 95% RH Duration: 96 +/- 5 hrs Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Vibration	Frequency: 10 ~ 50 Hz Amplitude: 1.52 mm (0.060 inches) Direction: X, Y and Z Time: each 30 min for all directions	No mechanical damage. After test, the device shall satisfy the specification in section 3.

7. REFLOW SOLDERING STANDARD CONDITIONS



- Measuring point of temperature in-out terminals of the device.
- Reflow Soldering
- Both convection and infrared rays
- Hot air
- Solder Cream: Sn96.5/Ag3.5